

SPECIFICATIONS FOR LCD MODULE

CUSTOMER	
CUSTOMER PART NO.	
AMPIRE PART NO.	AM-800600MFTNQW-06H
APPROVED BY	
DATE	

☐ Preliminary Specification

☐ Formal Specification

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APPROVED BY	CHECKED BY	ORGANIZED BY
Kokai	Lawlite	Mantle

This Specification is subject to change without notice.

Date: 2019/11/19 AMPIRE CO., LTD. 1

RECORD OF REVISION

Revision Date	Page	Contents	Editor
2019/11/19		New Release	Mantle

1. INSTRUCTION

Ampire 8.4" Display Module is a color active matrix TFT-LCD that uses amorphous silicon TFT as a switching device. This model is composed of a TFT-LCD panel, a driving circuit. This TFT-LCD has a high resolution (800(R.G.B) X 600) and can display up to 262,144 colors.

1.1 Features

- (1) Construction: a-Si TFT-LCD with driving system, White LED Backlight.
- (2) LCD type: Transmissive, Normally White
- (3) Number of the Colors: (a) 262K colors (LVDS 6 bits mode) (default)
 - (b) 16.2M colors (LVDS 8 bits mode).
- (4) LVDS Interface (Default setting: 6 bit mode).
- (5) LCD Power Supply Voltage: 3.3V single power input, built-in power supply circuit.
- (6) New LED Driver IC (VLED=12V).
- (7) ROHS compliant.

Date: 2019/11/19

2. PHYSICAL SPECIFICATIONS

Item	Specifications	unit
Display resolution(dot)	800RGB (W) x 600(H)	dots
Active area	170.40 (W) x 127.80(H)	mm
Pixel pitch	213 (W) x 213 (H)	um
Color configuration	R.G.B -stripe	
Overall dimension	203.0(W) x 145.5(H) x 8.0(D)	mm
Backlight unit	LED	
Display color	262K (default)	colors
Driver IC	Source IC : ILI6123H-9G Gate IC : ILI5600	

If user wants to change the default setting for mass production, please contact with Ampire. We'll apply a new P/N for you.

3. ABSOLUTE MAXIMUM RATINGS

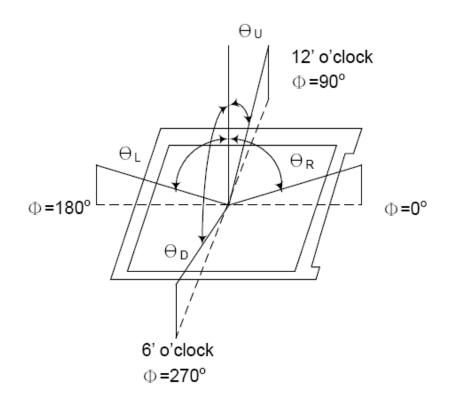
Item	Symbol	Min.	Max.	Unit	Note
Supply voltage range	VDD	-0.3	4	V	(1)
Voltage range at any terminal	VI	-0.3	VDD + 0.3	V	
Operating Temperature	Тор	-20	70	°C	
Storage Temperature	Tstg	-30	80	°C	

Note: All voltage values are with respect to the GND terminals unless otherwise noted.

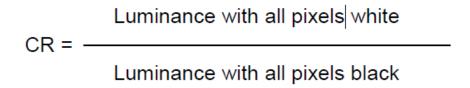
4. OPTICAL CHARACTERISTICS

Iten	n	Symbol	Condition	Min.	Тур.	Max.	Unit	Remark
Respo Tim		T _r +T _f	Θ=Ф=0°°	-	8	16	ms	Note 3
Contras	t ratio	CR		480	600	-		Note 2
	Тор	ΘL		65	75	-		
Viewing	Bottom	ΘR	CR≧10	65	75	-	deg.	Note1,2,
Angle	Left	ΘU	ON≦ IO	50	60	-	ueg.	140161,2,
	Right	ΘD		60	70	-		
Brightr	ness	Y _L	ILED=100mA ,25°C	640	800	-	cd/m²	Note 4
Brightr Unifor		BUNI			70		%	Note 5
Red chroi	maticity	XR						
Red Cilio	Пансну	YR						
Green chro	omoticity	XG						
Green cind	Jillalicity	YG	Θ=Φ=0°					Noto1 2
Plue chro	Blue chromaticity		$\Theta = \Psi = 0$					Note1,2,
Dide Cillo								
\M\hito ohro	White chromaticity			0.26	0.31	0.367		
Wille Cill	лпаныцу	YW		0.28	0.33	0.38		

Note 1 : Definition of viewing angle range

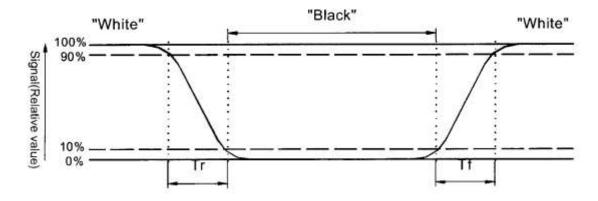


Note 2: Definition of Contrast Ratio (CR): measured at the center point of panel



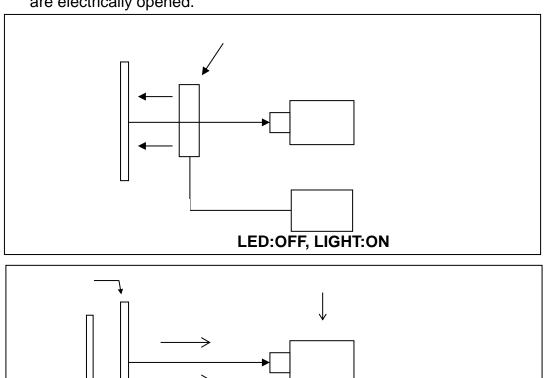
Note 3: Definition of response time:

The output signals of photo detector are measured when the input signals are changed from "black" to "white" (falling time) and from "white" to "black" (rising time),respectively. The response time is defined as the time intervalbetween the 10% and 90% of amplitudes. Refer to figure as below.



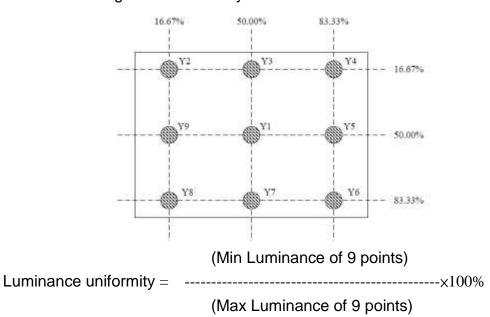
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Note 4: Measured at the center area of the panel when all the input terminals of LCD panel are electrically opened.



Note 5: Definition of brightness uniformity

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LED:ON, LIGHT:OFF

Note 6: Rubbing Direction (The different Rubbing Direction will cause the different optima view direction

Note 7 : Condition: Ta=25 $^{\circ}\text{C}$, Life time is estimated data.

Definitions of failure:

- i. LCM brightness becomes half of the minimum value.
- ii. LED doesn't light normally.

5. ELECTRICAL CHARACTERISTICS

5.1 Power Specification

Item	Symbol	Min.	Тур.	Max.	Unit	Note
Logic / LCD Drive Voltage	VDD	3.0	3.3	3.6	V	
VDD Current	ICC		120		mA	(1)

Note1: fv =60Hz , Ta=25°C , Display pattern : All Black

5.2 LVDS electrical Specification

Vcc = 3.0 - 3.6V, Ta = -10 - +70 °C

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
CMOS/	TTL DC SPECIFICATIONS					
V_{IH}	High Level Input Voltage		2.0		Vcc	V
$V_{\rm IL}$	Low Level Input Voltage		GND		0.8	V
	High Level output Voltage	I _{OH} =-4mA	2.4			V
Vol	Low Level Output Voltage	I _{OL} =4mA			0.4	V
I_{IN}	Input Current	0V ≦V _{IN} ≦Vcc			±10	μΑ
I_{PD}	Pull Down Current	R/F pin,V _{IH} =Vcc		2 (0	100	μΑ
IOS	Output Short Circuit Current	V _{OUT} =0V			-50	mA

LVDS DRIVER DC SPECIFICATIONS

V _{OD}	Differential Output Voltage	RL=100Ω	250	350	450	mV
ΔV_{OD}	Change in VOD between Complimentary Output States				35	mV
V _{OC}	Common Mode Voltage	1	1.125	1.25	1.375	V
ΔV _{OC}	Change in VOC between Complimentary Output States				35	mV
Ios	Output Short Circuit Current	V _{OUT} =0V,RL=100Ω			-24	mA
I _{OS}	Output TRI-STATE Current	/PDWN=0V, V _{OUT} =0V to Vcc			±10	μA

LVDS RECEIVER DC SPECIFICATIONS

V_{TH}	Differential Input High Threshold	$V_{OC}=+1.2V$		+100	mV
V_{TL}	Differential Input low Threshold		-100		mV
I_{IN}	Input Current	V _{IN} =+2.4V/0V Vcc=3.6V		±10	μА

6. BACKLIGHT UNIT

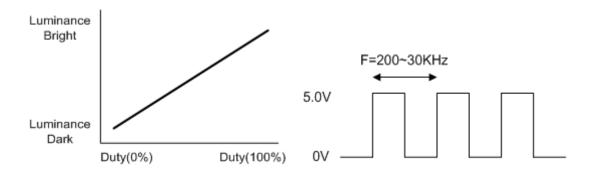
Item	Symbol	Min.	Тур.	Max.	Unit	Note
Input Voltage	VLED	10.8	12.0	12.6	V	
Input Current	ILED		440		mA	100% PWM duty
Dimming Frequency	Fpwm	200		30K	Hz	
Dimming Voltage High		1.4			V	
Dimming Voltage Low		0		0.8	V	
LED Forward Current	IF		100		mA	Ta=25°C
LED Forward Voltage	VF		39.6		V	IF=100mA, Ta=25°C
LED life time	LT					

Note 1: Ta means ambient temperature of TFT-LCD module.

Note 2: VLED, ILED, Fpwm are defined for LED Driver.

Note 3: IF, VF are defined for LED B/L

6.1 PWM Dimming Control



7. INTERFACE

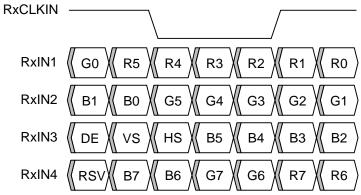
7.1 Interface Definition

CN1: LVDS Connector,STM MSB24013P20HA or Equivalent.

Pin no	Symbol	Function
1	VDD	POWER SUPPLY:3.3V
2	VDD	POWER SUPPLY:3.3V
3	UD	Vertical Reverse Scan Control.
4	LR	Horizontal Reverse Scan Control.
5	RXIN1-	Transmission Data of Pixels 1
6	RXIN1+	Transmission Data of Pixels 1
7	GND	Power Ground
8	RXIN2-	Transmission Data of Pixels 2
9	RXIN2+	Transmission Data of Pixels 2
10	GND	Power Ground
11	RXIN3-	Transmission Data of Pixels 3
12	RXIN3+	Transmission Data of Pixels 3
13	GND	Power Ground
14	RXCKIN-	Sampling Clock
15	RXCKIN+	Sampling Clock
16	GND	Power Ground
17	NC	No connection
18	NC	No connection
19	NC	LVDS 6 bits mode : No connection (default) LVDS 8 bit mode : (RXIN4-) Transmission Data of Pixels 4
20	NC	LVDS 6 bits mode : No connection (default) LVDS 8 bit mode : (RXIN4+) Transmission Data of Pixels 4

Mating Connector: STM P24013P20 or Equivalent.

8 bits LVDS input

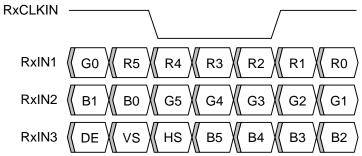


Note: R/G/B data 7: MSB, R/G/B data 0: LSB

Signal Name	Description	Remark
R7 R6 R5 R4 R3 R2 R1 R0	Red Data 7 (MSB) Red Data 6 Red Data 5 Red Data 4 Red Data 3 Red Data 2 Red Data 1 Red Data 0 (LSB)	Red-pixel Data Each red pixel's brightness data consists of these 8 bits pixel data.
G7 G6 G5 G4 G3 G2 G1 G0	Green Date 7 (MSB) Green Date 6 Green Date 5 Green Date 4 Green Date 3 Green Date 2 Green Date 1 Green Date 0 (LSB)	Green-pixel Data Each green pixel's brightness data consists of these 8 bits pixel data.
B7 B6 B5 B4 B3 B2 B1 B0	Blue Data 7 (MSB) Blue Data 6 Blue Data 5 Blue Data 4 Blue Data 3 Blue Data 2 Blue Data 1 Blue Data 0 (LSB)	Blue-pixel Data Each blue pixel's brightness data consists of these 8 bits pixel data.
RxCLKIN+ RxCLKIN-	LVDS Clock Input	
DE	Display Enable	
VS	Vertical Sync	
HS	Horizontal Sync	

6 bits LVDS input

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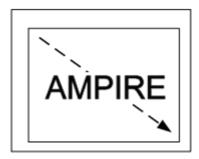


Note: R/G/B data 5: MSB, R/G/B data 0: LSB

Signal Name	Description	Remark
R5 R4 R3 R2 R1 R0	Red Data 5 (MSB) Red Data 4 Red Data 3 Red Data 2 Red Data 1 Red Data 0 (LSB)	Red-pixel Data Each red pixel's brightness data consists of these 6 bits pixel data.
G5 G4 G3 G2 G1 G0	Green Date 5 (MSB) Green Date 4 Green Date 3 Green Date 2 Green Date 1 Green Date 0 (LSB)	Green-pixel Data Each green pixel's brightness data consists of these 6 bits pixel data.
B5 B4 B3 B2 B1 B0	Blue Data 5 (MSB) Blue Data 4 Blue Data 3 Blue Data 2 Blue Data 1 Blue Data 0 (LSB)	Blue-pixel Data Each blue pixel's brightness data consists of these 6 bits pixel data.
RxCLKIN+ RxCLKIN-	LVDS Clock Input	
DE	Display Enable	
VS	Vertical Sync	
HS	Horizontal Sync	

_	of scan I input	Scanning direction
UD	LR	
GND	GND	Up to Down, Left to Right
VDD	VDD	Down to Up, Right to Left
GND	VDD	Up to Down, Right to Left
VDD	GND	Down to Up, Left to Right

UD : L, LR : L

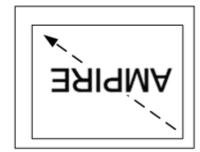


UD : H, LR : L



UD: H, LR: H



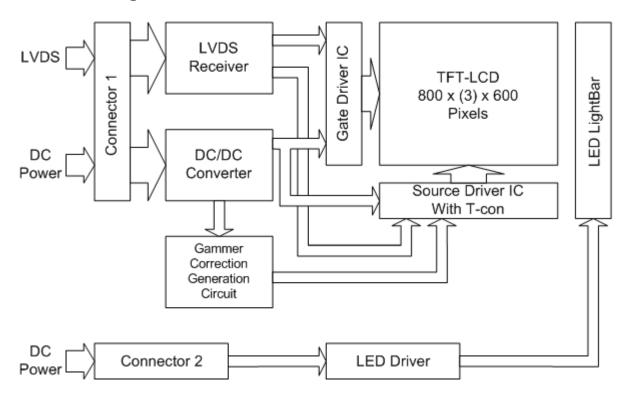


CN2: LED Driver Connector, ENTERY 3808K-F04N-03L or Equivalent.

Pin no	Symbol	Function
1	VCC	12V input
2	GND	GND
3	ENABLE	+3.3V:ON, 0V:OFF
4	Dimming	PWM

Mating Connector: ENTERY H208K-P04N-02B or Equivalent.

7.2 Block Diagram



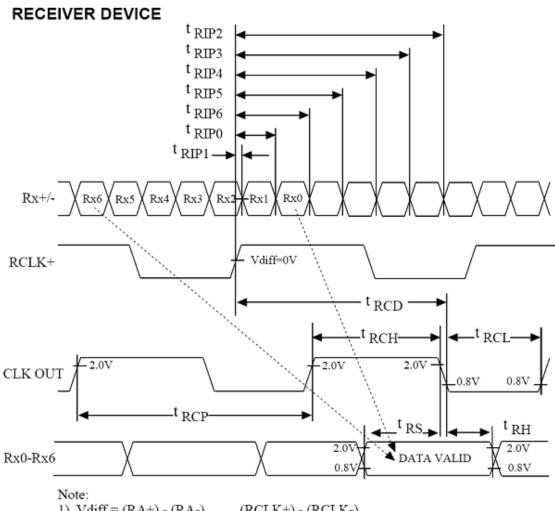
8. AC Timing characteristic

8.1 AC Timing characteristic of LVDS

Switching Characteristics Vcc = 3.0 - 3.6V, Ta = -10 - +70 $^{\circ}C$

RECEIVER

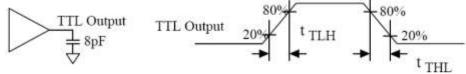
t RCP	CLK OUT Period	11.76	T	50.0	ns
t RCH	CLK OUT High Time		4T/7		ns
t RCL	CLK OUT Low Time		3T/7		ns
t RCD	RCLK+/- to CLK OUT Delay		5T/7		ns
t _{RS}	TTL Data Setup to CLK OUT	3T/7-2.5			ns
t _{RH}	TTL Data Hold from CLK OUT	4T/7-3.5			ns
t TLH	TTL Low to High Transition Time		3.0	5.0	ns
t THL	TTL High to Low Transition Time		3.0	5.0	ns
t RIP1	Input Data Position 0 (T=11.76ns)	-0.4	0.0	0.4	ns
t RIPO	Input Data Position 1 (T=11.76ns)	T/7-0.4	T/7	T/7+0.4	ns
t _{RIP6}	Input Data Position 2 (T=11.76ns)	2T/7-0.4	2T/7	2T/7+0.4	ns
t RIP5	Input Data Position 3 (T=11.76ns)	3T/7-0.4	3T/7	3T/7+0.4	ns
t _{RIP4}	Input Data Position 4 (T=11.76ns)	4T/7-0.4	4T/7	4T/7+0.4	ns
t _{RIP3}	Input Data Position 5 (T=11.76ns)	5T/7-0.4	5T/7	5T/7+0.4	ns
t _{RIP2}	Input Data Position 6 (T=11.76ns)	6T/7-0.4	6T/7	6T/7+0.4	ns
t RPLL	Phase Lock Loop Set			10.0	ms



1) Vdiff = (RA+) - (RA-), (RCLK+) - (RCLK-)

RECEIVER DEVICE TRANSITION TIMES

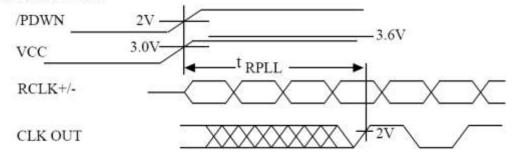
TTL Output



TTL output load

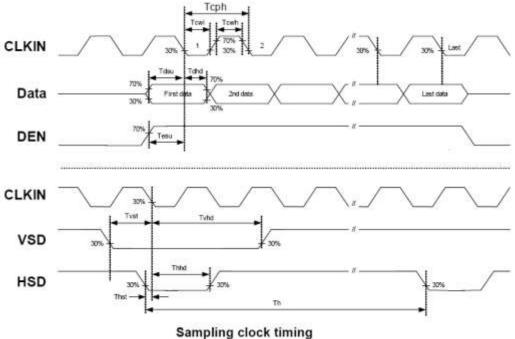
PHASE LOCK LOOP SET TIME

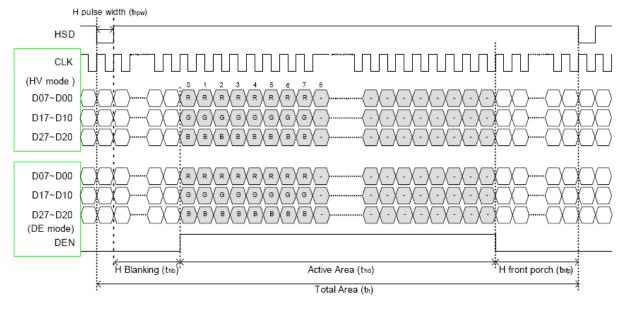
RECEIVER DEVICE



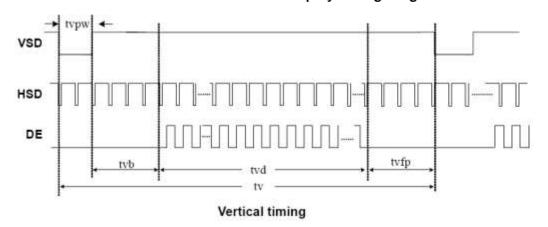
8.2 AC Timing characteristic of Panel

Item	Symbol	Min.	Тур.	Max.	Unit	Note
DCLK cycle time	Tcph	20			ns	
DCLK frequency	fclk		40	50	MHz	
DCLK pulse duty	Tcwh	40	50	60	%	
VSD setup time	Tvst	8			ns	
VSD hold time	Tvhd	8			ns	
HSD setup time	Thst	8			ns	
HSD hold time	Thhd	8			ns	
Data setup time	Tdsu	8			ns	
Data hold time	Tdhd	8			ns	
DE setup time	Tesu	8			ns	
DE hold time	Tehd	8			ns	
Horizontal display area	thd		800		Tcph	
HSD period time	th		1000		Tcph	
HSD pulse width	thpw	1	48		Tcph	
HSD back porch	thb		40		Tcph	
HSD front porch	thfp		112		Tcph	
Vertical display area	tvd		600		th	
VSD period time	tv		660		th	
VSD pulse width	tvpw		3		th	
VSD back porch	tvb		39		th	
VSD front porch	tvfp		18		th	



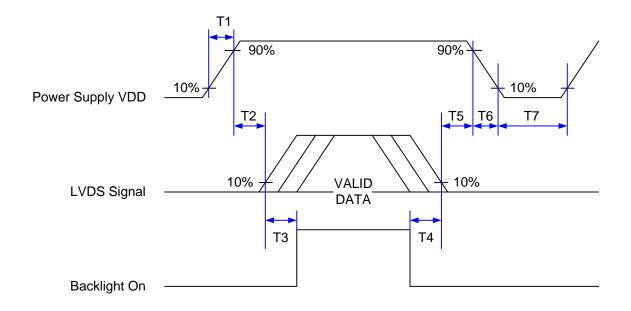


Horizontal display timing range



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8.3 Power ON/OFF Sequence



8.3.1 Power ON/OFF sequence timing

Symbol		Unit		
Symbol	Min.	Тур.	Max.	Offic
T1	0.5		20	ms
T2	0	40	50	ms
Т3	200			ms
T4	200			ms
T5	0	40	50	ms
Т6	0		20	ms
T7	1000			ms

9. Reliability Test Items

Test Item	Test Conditions	Note
High Temperature Operation	70±3°C , t=240 hrs	
Low Temperature Operation	-20±3°C , t=240 hrs	
High Temperature Storage	80±3°C , t=240 hrs	1,2
Low Temperature Storage	-30±3°C , t=240 hrs	1,2
Storage at High Temperature and Humidity	60°C, 90% RH , 240 hrs	1,2
Thermal Shock Test	-20°C (30min) ~ 70°C (30min) 100 cycles	1,2
Vibration Test (Packing)	Sweep frequency: 10 ~ 55 ~ 10 Hz/1min Amplitude: 0.75mm Test direction: X.Y.Z/3 axis Duration: 30min/each axis	2

- Note 1: Condensation of water is not permitted on the module.
- Note 2: The module should be inspected after 1 hour storage in normal conditions (15-35°C, 45-65%RH).
- Note 3: The module shouldn't be tested more than one condition, and all the test conditions are independent.
- Note 4: All the reliability tests should be done without protective film on the module.
 - Current drain should be smaller than the specific value.
 - Function of the module should be maintained.
 - Appearance and display quality should not have degraded noticeably.
 - Contrast ratio should be greater than 50% of the initial value.

10. USE PRECAUTIONS

10.1 Handling precautions

- 1. The polarizing plate may break easily so be careful when handling it. Do not touch, press or rub it with a hard-material tool like tweezers.
- 2. Do not touch the polarizing plate surface with bare hands so as not to make it dirty. If the surface or other related part of the polarizing plate is dirty, soak a soft cotton cloth or chamois leather in benzine and wipe off with it. Do not use chemical liquids such as acetone, toluene and isopropyl alcohol. Failure to do so may bring chemical reaction phenomena and deteriorations.
- 3. Remove any spit or water immediately. If it is left for hours, the suffered part may deform or decolorize.
- 4. If the LCD element breaks and any LC stuff leaks, do not suck or lick it. Also if LC stuff is stuck on your skin or clothing, wash thoroughly with soap and water immediately.

10.2 Installing precautions

- 1. The PCB has many ICs that may be damaged easily by static electricity. To prevent breaking by static electricity from the human body and clothing, earth the human body properly using the high resistance and discharge static electricity during the operation. In this case, however, the resistance value should be approx. $1M\Omega$ and the resistance should be placed near the human body rather than the ground surface. When the indoor space is dry, static electricity may occur easily so be careful. We recommend the indoor space should be kept with humidity of 60% or more. When a soldering iron or other similar tool is used for assembly, be sure to earth it.
- 2. When installing the module and ICs, do not bend or twist them. Failure to do so may crack LC element and cause circuit failure.
- 3. To protect LC element, especially polarizing plate, use a transparent protective plate (e.g., acrylic plate, glass etc) for the product case.
- 4. Do not use an adhesive like a both-side adhesive tape to make LCD surface (polarizing plate) and product case stick together. Failure to do so may cause the polarizing plate to peel off.

10.3 Storage precautions

- 1. Avoid a high temperature and humidity area. Keep the temperature between 0°C and 35°C and also the humidity under 60%.
- 2. Choose the dark spaces where the product is not exposed to direct sunlight or fluorescent light.
- 3. Store the products as they are put in the boxes provided from us or in the same conditions as we recommend.

10.4 Operating precautions

- Do not boost the applied drive voltage abnormally. Failure to do so may break ICs.
 When applying power voltage, check the electrical features beforehand and be
 careful. Always turn off the power to the LC module controller before removing or
 inserting the LC module input connector. If the input connector is removed or
 inserted while the power is turned on, the LC module internal circuit may break.
- 2. The display response may be late if the operating temperature is under the normal standard, and the display may be out of order if it is above the normal standard. But this is not a failure; this will be restored if it is within the normal standard.
- 3. The LCD contrast varies depending on the visual angle, ambient temperature, power voltage etc. Obtain the optimum contrast by adjusting the LC dive voltage.
- 4. When carrying out the test, do not take the module out of the low-temperature space suddenly. Failure to do so will cause the module condensing, leading to malfunctions.
- 5. Make certain that each signal noise level is within the standard (L level: 0.2Vdd or less and H level: 0.8Vdd or more) even if the module has functioned properly. If it is beyond the standard, the module may often malfunction. In addition, always connect the module when making noise level measurements.
- 6. The CMOS ICs are incorporated in the module and the pull-up and pull-down function is not adopted for the input so avoid putting the input signal open while the power is ON.
- 7. The characteristic of the semiconductor element changes when it is exposed to light emissions, therefore ICs on the LCD may malfunction if they receive light emissions. To prevent these malfunctions, design and assemble ICs so that they are shielded from light emissions.
- 8. Crosstalk occurs because of characteristics of the LCD. In general, crosstalk occurs when the regularized display is maintained. Also, crosstalk is affected by the LC drive voltage. Design the contents of the display, considering crosstalk.

10.5 Other

- 1. Do not disassemble or take the LC module into pieces. The LC modules once disassembled or taken into pieces are not the guarantee articles.
- 2. Do not keep the LCD at the same display pattern continually. The residual image will happen and it will damage the LCD. Please use screen saver.
- 3. AMIPRE will provide one year warranty for all products and three months warrantee for all repairing products.

11. OUTLINE DIMENSION

